

# **Engineering/Process Change Notice**

**ECN/PCN No.: 4745** 

For Manufacturer				
Product Description:	Abracon Part Nu	ımber / Part	☐ Documentation only	⊠ Series
Clipped Sinewave TCXO	Series:	547	□ ECN	☐ Part Number
			⊠ EOL	
Affected Revision:	New Revision:		Application:	☐ Safety
Rev M	E	OL		☐ Non-Safety
Prior to Change:				
Rev M				
After Change: EOL				
Cause/Reason for Change:				
Discontinuation based on manufacturing of	apabilities.			
	Chan	ge Plan		
Effective Date:	Additional Remarks	:		
4/26/24				
Change Declaration:				
Issued Date:	Issued By:		Issued Department:	
4/26/24	Stephanie Lopez		Engineering	
Approval:	Approval:		Approval:	
Thomas Culhane	Reuben Quintanilla		Ying Huang	
Engineering Director	Quality Director		Purchasing Di	rector
	For Abrac	on EOL only		
Last Time Buy (if applicable): N/A	Alternate Part Numb		per / Part Series: N/A	
Additional Approval:	Additional Approval	:	Additional Approval:	
	Customer Appro	oval (If Applicable)		
Qualification Status:				
	• •	☐ Not accepted		
Note: It is considered approved if there is r	no feedback from the c	-	r ECN/PCN is released.	
Customer Part Number:		Customer Project:		
Company Name:	Company Represent	ative:	Representative Signature	:
Customer Remarks:				

Form #7020 | Rev. G | Effective: 02/22/2021 |

















### 2.5 mm x 3.2 mm Ceramic Package SMD TCXO

### **I547/I747 Series**

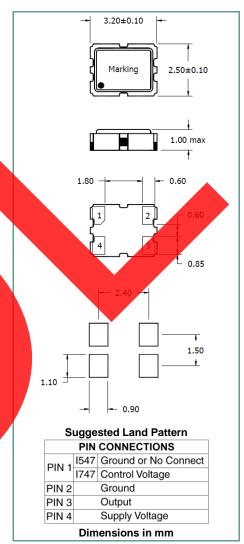
#### **Product Features:**

Clipped Sinewave Analog Compensation Available ±0.5ppm Stability RoHS Compliant / Pb-free

## **Applications:**

GPS Smart Meters Wireless Base Stations Sonet / SDH T1/E1, T3/E3

Frequency	10MHz to 52MHz
Frequency Tolerance @ 25° C	±2.0ppm after second reflow
Frequency Stability	
Vs Temperature	See Part Numbering Guide
Vs Supply Voltage (± 5%)	±0.2ppm Maximum
Vs Load (10%)	±0.2ppm Maximum
Output Level	
Clipped Sinewave	0.8V p-p Minimum
Output Load	
Clipped Sinewave	10KOhms / 10 pF
Start Time (90% of Vp-p)	3.0mSec Maximum
Aging	±1ppm / Year Maximum
Supply Voltage	See Part Numbering Guide, tolerance ± 5%
Current	
<32MHz	1.5mA Maximum
>32mHz	2.0mA Maximum
Voltage Control	1.5Vdc ±1.0Vdc ± 5.0ppm Minimum (Only for I747)
Operating Temperature Range	See Part Numbering Guide
Storage Temperature Range	-40°C to +85°C
Phase Noise (typical)	-87 dBc/Hz at 10Hz
	-112 dBc/Hz at 100Hz
	-135 dBc/Hz at 1KHz
	-145 dBc/Hz at 10KHz
Compensation	Analog



### **Part Numbering Guide**

Package	Operating Temperature	FrequencyStability vs Temperature	Supply Voltage	Frequency
	$7 = 0^{\circ}\text{C to } +50^{\circ}\text{C}$	*, ** Y = ±0.5ppm	3 = 3.3V	
	1 = 0°C to +70°C	*N = ±1.0ppm	7 = 3.0V	
I547 (Clipped Sinewave TCXO)	$3 = -20^{\circ}\text{C} \text{ to } +70^{\circ}\text{C}$	*O = ±1.5ppm	8 = 2.8V	
I747 (Clipped Sinewave TCVCXO)	$5 = -30^{\circ}$ C to +85°C	*P = ±2.0ppm	2 = 2.7V	- 20.000 MHz
	$2 = -40^{\circ}$ C to +85°C	Q = ±2.5ppm	1 = 1.8V	
		$R = \pm 3.0 ppm$		
		$J = \pm 5.0$ ppm		

NOTE: It is recommended that a 0.01µF bypass capacitor be connected between Vdd (Pin 4) and Ground (Pin 2) to minimize power supply noise. It is recommended that an external 0.01µF AC-coupling capacitor be connected to output (Pin 3) of the device. For the TXCO (I547), it is recommended that Pin 1 should not be left floating but be connected to Ground.

QUALITY SYSTEM CERTIFIED = ISO 9001 = Rev: 12/13/17\_M



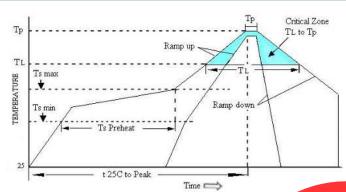




# 2.5 mm x 3.2 mm Ceramic Package SMD TCXO

# **I547/I747 Series**

#### Pb Free Solder Reflow Profile:



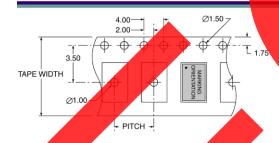
Units are backward compatible with +240°C reflow processes

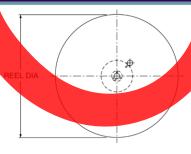
Ts max to T <sub>L</sub> (Ramp-up Rate)	3°C / second max
Preheat	
Temperature min (Ts min)	150°C
Temperature typ (Ts typ)	175°C
Temperature max (Ts max)	200°C
Time (Ts)	60 to 180 seconds
Ramp-up Tate (T <sub>L</sub> to Tp	3°C / second max
Time Maintained Above	
Temperature (T <sub>L</sub> )	217°C
Time (T <sub>L)</sub>	60 to 150 seconds
Peak Temperature (Tp)	260°C max for 10
	seconds
Time within 5°C to Peak	20 to 40 seconds
Temperature (Tp)	20 to 40 seconds
Ramp-down Rate	6°C / second max
Tune 25°C to Peak Temperature	8 minutes max

#### Package Information:

MSL = 1 (package does not contain plastic, storage life is unlimited under normal room conditions)
Termination = e4 (Au over Ni over W base metallization)

#### **Tape and Reel Information:**





PITCH	4.00
TAPE WIDTH	8.00
REEL DIA	180
QTY PER REEL	3,000

#### Tape and Reel Information:

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition B
Mechanical Vibration	MIL-SPD-883, Method 2007, Condition A
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS Compliant
Solderability	JESD22-B102 Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s
Solvent Resistance	MIL-STD-202, Method 215